BAT54SLT1

Preferred Device

Dual Series Schottky Barrier Diodes

These Schottky barrier diodes are designed for high speed switching applications, circuit protection, and voltage clamping. Extremely low forward voltage reduces conduction loss. Miniature surface mount package is excellent for hand held and portable applications where space is limited.

- Extremely Fast Switching Speed
- Low Forward Voltage 0.35 V (Typ) @ $I_F = 10 \text{ mAdc}$
- Pb–Free Package May be Available. The G–Suffix Denotes a Pb–Free Lead Finish

Rating	Symbol	Value	Unit	
Reverse Voltage	V _R	30	Volts	
Forward Power Dissipation @ T _A = 25°C Derate above 25°C	P _F	225 1.8	mW mW/°C	
Forward Current (DC)	١ _F	200 Max	mA	
Junction Temperature	Τ _J	125 Max	°C	
Storage Temperature Range	T _{stg}	-55 to +150	°C	

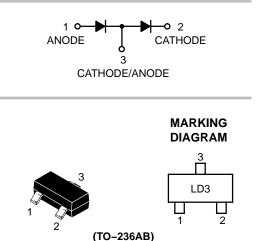
MAXIMUM RATINGS (T_J = 125°C unless otherwise noted)



ON Semiconductor®

http://onsemi.com

30 VOLT DUAL HOT-CARRIER DETECTOR AND SWITCHING DIODES



SOT-23 CASE 318 Style 11

ORDERING INFORMATION

Device	Package	Shipping [†]
BAT54SLT1	SOT-23	3000/Tape & Reel
BAT54SLT1G	SOT-23 (Pb-Free)	3000/Tape & Reel

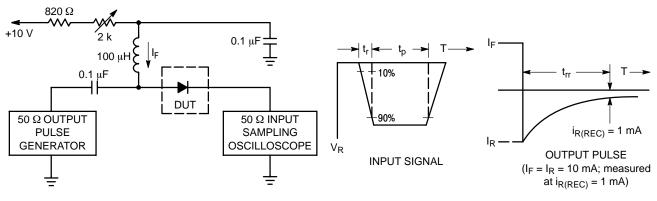
⁺For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Preferred devices are recommended choices for future use and best overall value.

BAT54SLT1

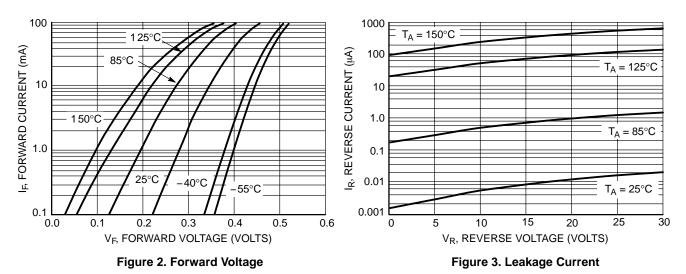
Characteristic	Symbol	Min	Тур	Max	Unit
Reverse Breakdown Voltage (I _R = 10 μ A)	V _{(BR)R}	30	-	-	Volts
Total Capacitance (V _R = 1.0 V, f = 1.0 MHz)	C _T	-	7.6	10	pF
Reverse Leakage (V _R = 25 V)	۱ _R	-	0.5	2.0	μAdc
Forward Voltage (I _F = 0.1 mAdc)	V _F	-	0.22	0.24	Vdc
Forward Voltage (I _F = 30 mAdc)	V _F	-	0.41	0.5	Vdc
Forward Voltage (I _F = 100 mAdc)	V _F	-	0.52	0.8	Vdc
Reverse Recovery Time $(I_F = I_R = 10 \text{ mAdc}, I_{R(REC)} = 1.0 \text{ mAdc}, Figure 1)$	t _{rr}	-	_	5.0	ns
Forward Voltage (I _F = 1.0 mAdc)	V _F	-	0.29	0.32	Vdc
Forward Voltage (I _F = 10 mAdc)	V _F	-	0.35	0.40	Vdc
Forward Current (DC)	١ _F	-	-	200	mAdc
Repetitive Peak Forward Current	I _{FRM}	-	-	300	mAdc
Non–Repetitive Peak Forward Current (t < 1.0 s)	I _{FSM}	-	-	600	mAdc

BAT54SLT1



Notes: 1. A 2.0 k Ω variable resistor adjusted for a Forward Current (I_F) of 10 mA. 2. Input pulse is adjusted so I_{R(peak)} is equal to 10 mA. 3. t_p » t_{rr}





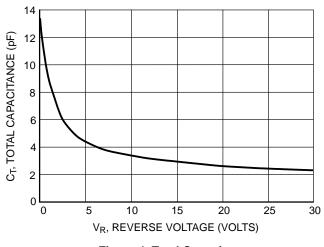


Figure 4. Total Capacitance

BAT54SI T1

PACKAGE DIMENSIONS

SOT-23 (TO-236)

CASE 318-08 **ISSUE AH**

S В

C

н₫

G

NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: INCH.
- 2
- CONTROLLING DIMENSION, INCL.
 MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAI
- 318-03 AND -07 OBSOLETE, NEW STANDARD 4. 318-08

MILLIMETERS

MIN MAX

3.04

1.40

1.11

0.50

2.04

0.100

0.177

1.02

2.64

0.60

0.69

2 80

1.20

0.89

0.37

1.78

0.013

0.085

0.35

0.89

2.10

0.45

	010-0	0.		
		INCHES		
	DIM	MIN	MAX	ľ
	Α	0.1102	0.1197	ĺ
	В	0.0472	0.0551	ĺ
	С	0.0350	0.0440	ĺ
	D	0.0150	0.0200	
	G	0.0701	0.0807	I
	н	0.0005	0.0040	ĺ
	J	0.0034	0.0070	ĺ
	K	0.0140	0.0285	I
	L	0.0350	0.0401	l
I_ 1	S	0.0830	0.1039	ĺ
J =	V	0.0177	0.0236	ĺ
	etvi			



PIN 1. ANODE 2 CATHODE

> CATHODE-ANODE 3.

SOLDERING FOOTPRINT*

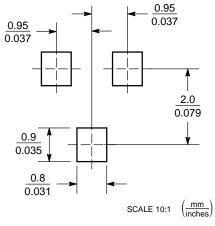


Figure 5. SOT-23

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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